



DATE: 28/01/2022

INVITATION OF BIDS FOR MULTIPURPOSE CONVERTIBLE WIRE BONDER

ENQUIRY NO: IITGOA/2021-22/051 DTD 28/01/2022

1. Quotations are invited in two bid system for the procurement of Multipurpose Convertible Wire Bonder in separate envelopes. Please mention the above-mentioned title, enquiry number and due date for submission of bids on the sealed cover to avoid the bid being declared invalid.

2. The address and contact numbers for sending bids or seeking clarifications regarding this RFP are given below –

**Deputy Registrar,
Stores & Purchase Section,
IIT GOA, At GEC Campus,
Farmagudi, Ponda – Goa.
403 401
dr_sp@iitgoa.ac.in / purchase@iitgoa.ac.in**

3. This bid enquiry is divided into three parts as follows:

- a. Part I – Contains General Information such as the time, place of submission and opening of tenders, Validity period of tenders, etc.
- b. Part II – Contains Instructions for the Bidders and essential details of the items/services required, such as the Schedule of Requirements (SOR), Technical Specifications, Delivery Period, Place of Delivery and Consignee details.
- c. Part III – Contains Price Bid format, other details etc.

4. This bid enquiry is being issued with no financial commitment and the Institute reserves the right to change or vary any part thereof at any stage and to withdraw it at any stage.



Part I – General information

Tender No.		IITGOA/2021-22/051	
Tender Date		28.01.2022	
Tender Category		Goods	
Tender Type		Open	
No. of Envelopes		2	
Covers Information / Submission of Bids			
Cover No.	Cover Type	Description	Document Type
1	Technical	Technical Specification, Tender Document, Schedule of Requirement and Compliance, Bidders Information/Indian Agent Information, PAC, Declaration of Local Content, Undertaking for Bid Security etc.	.pdf
2	Financial	Financial Bid	.pdf
<p>Two Bid System:</p> <ul style="list-style-type: none"> ❖ The two-bid system will be followed for this tender. In this system bidder must submit their offer in separate sealed envelopes as – Technical Bid and Financial Bid. ❖ Separate technical bid and financial bid envelopes should be clearly marked as "Envelope No. 1 - Technical Bid" and "Envelope No. 2 - Financial Bid". ❖ Both these sealed covers are to be put in a bigger cover which should also be sealed and duly super scribed with our Tender No., Due Date and Name of the items quoted and to be submitted to the concern department/section mentioned in tender document. ❖ Bids should be forwarded by Bidders under their original memo / letter head inter alia furnishing details like GST number, Bank Details etc. and complete postal & e-mail address of their office. <p>Note:</p> <ul style="list-style-type: none"> • The technical offer should not contain any price information. If the price quoted is submitted in technical bid the tender will be rejected at the sole discretion of IIT Goa. • Initially Technical Bids will be opened and evaluated by the purchase committee. Financial Bid of only Technically qualified bidders will be opened later. • Contract/ Purchase Order will be awarded to the lowest bidder(L1) of Financial Bid among them. 			
Form of Contract		Supply	
Bid Validity (Days):		120 days	

Period of Work/Delivery Period (Days):	45 days
Pre-Bid Meeting Date & Time:	Will be decided on request
Pre-Bid Meeting Place & Address:	N/A
Modification and Withdrawal of Bids:	A prospective bidder who requires clarification regarding the contents of the bidding documents shall notify to the Buyer in writing about the clarifications sought not later than 7 (Seven) days prior to the date of opening of the Bids. Copies of the query and clarification by the purchaser will be sent to all prospective bidders who have participated the bidding documents.
Clarification regarding contents of the tender document/RFP:	A bidder may modify or withdraw his bid after submission provided that the written notice of modification or withdrawal is received by the Buyer prior to deadline prescribed for submission of bids. A withdrawal notice may be sent by email but it should be followed by a signed confirmation copy to be sent by post and such signed confirmation should reach the purchaser not later than the deadline for submission of bids. No bid shall be modified after the deadline for submission of bids. No bid may be withdrawn in the interval between the deadline for submission of bids and expiration of the period of bid validity specified. Withdrawal of a bid during this period will result in Bidder's forfeiture of bid security.
Rejection of bids:	Canvassing by the Bidder in any form, unsolicited letter and post-tender correction may invoke rejection. Conditional tenders will be rejected.
Unwillingness to quote:	Bidders unwilling to quote should ensure that intimation to this effect reaches before the due date and time of opening of the Bid, failing which the defaulting Bidder may be delisted for the given range of items as mentioned in this RFP.
Contract Type:	Tender
Delivery Location:	Indian Institute of Technology Goa At Goa Engineering College Campus, Bhauasaheb Bandodkar Technical Education Complex, Veling, Farmagudi, Ponda, Goa
Pin Code:	403401
Bid Submission End Date/Date & Time Submission:	25.02.2022 at 17:00hrs
Place of Submission of Bid:	Stores & Purchase Section, IIT Goa, Admin Block, At GEC Campus, Farmagudi, Ponda, Goa-403401
Bid Opening Date & Time:	28.02.2022 at 15:00 hrs
Bid Opening Place:	IIT Goa, Admin Block, At GEC Campus, Farmagudi, Ponda, Goa-403401

Other Terms & Conditions:	As mentioned in technical specification
Technical Clarification:	Name: Dr. Bidhan Pramanick School of Electrical Sciences IIT Goa Email: bidhan@iitgoa.ac.in
Tender Inviting Authority:	Name: Registrar Address: IIT Goa Email: dr_sp@iitgoa.ac.in / purchase@iitgoa.ac.in IIT Goa, Admin Block, At GEC Campus, Farmagudi, Ponda, Goa - 403401
Signing Authority:	Registrar



Part II: Instructions to Bidders

1. **Schedule of Requirements** – List of items are attached as **Annexure ‘A’**
2. **Technical Details:** Technical details are attached in **Annexure ‘B’**
3. **Two-Bid System:** In respect of Two-bid system, Bidders are required to furnish clause by clause compliance of specifications bringing out clearly the deviations from specification, if any.

i) The Bidders are advised to submit the following documents along with Technical Bid–

- a) Compliance certificate in the following format;

Para of tender enquiry specification item-wise (As per annexure B)	Specification of Item offered	Compliance – whether YES/NO	In case of non-compliance, deviation to be specified in unambiguous terms

The offers must strictly be as per the specifications given in Annexure-A. At the same time, it must be kept in mind that mere copying of our specifications in the quotation shall not make the technical bid eligible for consideration. **A bid has to be supported with original catalogue (not of photo copy) of the quoted model duly signed by the OEM and the same must be sent along with the technical bid.** The quoted model should not become obsolete for a minimum period of 5 years (This is for the availability of spares). Therefore, the model quoted should invariably be highlighted in the leaflet/literature enclosed with the quotation. Non-compliance with above shall be treated as incomplete/ambiguous and the bid may be ignored without giving an opportunity to the bidder for further clarification/negotiation etc.

- b) Bidders & Indian Agent’s Information (**Annexure C**).
- c) A copy of Indian Agent Agreement / Authorization letter from OEM / OEMs along with tender to be submitted by All Indian Agents, if the manufacturer/supplier is based in abroad.
- d) GST and PAN details
- e) The Bidder should provide a list of customers of previous supply of a similar/ same range of equipment to IIT’s/ NIT’s/Universities with contact details.
- f) IIT Goa shall compare all substantially responsive bids to determine the lowest evaluated bid. The Institute is following and abide with the revised Public Procurement (Preference to Make in India), Order 2017 P- 45021/2/2017 – B. E. -II dated 16.09.20 issued by DPIIT, Ministry of Commerce and Industry, Govt. of India & subsequent amendments/instructions of Ministry. Accordingly, preference will be given to the make in India products while evaluating the bids. However, it is sole responsibility of the bidder(s) to specify the product quoted by them is of Make in India along with respective documentary evidence in the technical bid itself.
- g) Any bidder from a country which shares a land border with India will be eligible to bid in this tender only if the bidder is registered with the Department for Promotion of Industry and Internal Trade (DPIIT). This is also applicable for bidders bidding for finished goods procured directly/indirectly from the vendors from the countries sharing land border with India.

ii) The following documents should be submitted along with Financial Bid–

- a) Price Bid. (**Annexure D**)
- b) Previous order of supplies/Justification of quoted rates. (**Annexure E**)

4. **Delivery Period** – Supply to be made within 45 days from the effective date of issuance of Purchase Order. Please note that P.O. can be cancelled unilaterally by the Institute in case items are not received within the delivery period. Extension of delivery period will be at the sole discretion of the Institute, with applicability of LD clause.

5. **Delivery and Transportation** - Place for supply / installation is '**Indian Institute of Technology Goa, Ponda – Goa**'. The transportation cost & insurance charges up to the destination is to be borne by the bidder for indigenous offer.

Part III: Conditions of Contract

1. Award of Contract:

- i. IIT Goa shall award the contract to the technically qualified eligible BIDDER whose bid has been determined as the lowest evaluated financial bid.
- ii. If more than one BIDDER happens to quote the same lowest price, IIT Goa reserves the right to award the contract to more than one BIDDER or any BIDDER.

2. Prices:

For Import Supplies:

- i. It is mandatory to quote prices in both, FOB and CIP Mumbai basis.
- ii. In case of multiple options of same product, bidders are requested to quote only one best option and not multiple options.

For Indigenous Supplies:

- i. It is mandatory to quote prices in FOR, IIT Goa basis only.
- ii. In case of multiple options of same product, bidders are requested to quote only one best option and not multiple options.

3. Pre-installation:

- i. Please also mention the pre-installation requirements for the equipment like ambient temperature, humidity, civil work, weather specifications, power specifications, etc. When items are provided full performance satisfaction should be demonstrated.

4. Installation:

- i. Supplier shall be responsible for installation / demonstration wherever applicable and for after sales service during the warranty period and thereafter as mentioned in the contract.
- ii. Installation / demonstration to be arranged by the supplier free of cost and the same is to be done within 15 days of the arrival of the equipment at site.

5. Training:

- i. The supplier shall submit training proposal for the operation and maintenance to the personnel of IIT Goa on the offered equipment/machinery.
- ii. Wherever needed, our technical persons should be trained by the supplier at the project site free of cost. In case the person is to be trained at supplier's site abroad or in India it should be mentioned in the quotation clearly. The supplier should bear all the expenses for such training including 'to & fro' fares and lodging & boarding charges.

6. Terms of Payment:

- i. For foreign currency payments: 90% payment by letter of credit and balance 10% will be paid by wire transfer after satisfactory installation and commissioning.
- ii. For payments in INR: 100% within 30 days after the delivery and successful installation of the items at IIT Goa.

7. Legal Matter:

- i. All disputes are subject to Goa jurisdiction only.

8. Rights to Accept, Reject, Amend, Modify:

- i. The basic eligibility conditions and conditions of contract are broad guidelines for pre-qualification and the Director, IIT Goa reserves the right to relax / alter / modify / add / delete any or all the conditions without notice. The Director, IIT Goa also reserves the right to accept or reject any or all bids without assigning any reason in public interest.

9. Penalty/ Liquidated Damages:

- i. Timely delivery is essence of the contract and hence if any consignment be delayed, liquidated damages at the rate 0.5% of the price of the delayed consignment, for each week or part whereof shall be levied and recovered subject to maximum of 10% of total purchase order value.
- ii. IIT Goa reserves the right to cancel the order in case the delay is more than 6 weeks. Penalties if any will be recovered by forfeiting PBG at vendor's cost and risks.

10. Supervision of Erection and Commissioning:

- i. Successful BIDDER shall depute concerned specialist, for supervision of erection & commissioning of the machine to be carried out. The successful BIDDER shall make necessary arrangement at their own expenses for stay, transport and other expenses of their Specialist during their stay in Goa which also includes imparting free of cost training to IIT Goa personnel.

11. Performance Guarantee (GFR 2017 Rule 171):

- i. Performance Guarantee Bond is mandatory.
- ii. Successful tenderer/ bidder should submit performance guarantee as prescribed above to be sent to The Deputy Registrar, Stores & Purchase Department, IIT Goa on or before 15 days from the due date of issue of order acknowledgement. The PBG to be furnished in the form of bank guarantee as per pro forma or annexure of the tender documents, for an amount covering 3% of the purchase order value.
- iii. The Performance Guarantee should be established in favor of "The Registrar, IIT Goa".
- iv. PBG to be established through any of the National Banks (whether situated at Goa or outstation) with a clause to enforced the same on their local branch of Goa or any scheduled bank (other than national bank) situated at Goa. Bonds issued by co-operative banks will not be accepted.
- v. Performance Guarantee Bond shall be for the due and faithfully performance of the contract and shall remain binding, notwithstanding such variations, alterations for extensions of time as may be made, given, conceded or agreed to between the successful tenderer and the purchaser under the terms & conditions of acceptance to the tender.
- vi. The successful tenderer is entirely responsible for due performance of the contract in letter and spirit and all other documents referred to in the acceptance of tenders.
- vii. The PBG shall be kept valid during the period of contract and shall continue to be enforceable for a period of one year/two years (as mentioned in the tender document) or up to warranty period, plus 60 days whichever is later from the date of order acknowledge. In case PBG needs extensions up to warranty period then supplier shall initiate extensions to PBG one month prior to expiry of PBG.
- viii. **No interest shall be payable by the buyer to the Bidder on PBG.**

List of items required

Sl. No.	Description of Items	Qty
1	Multipurpose Convertible Wire Bonder	01

Technical Specifications

Instructions:

1. Vendor needs to mention at the beginning of the tender document that whether they are participating for Mandatory item (Multipurpose Convertible Wire Bonder) or Optional Item (Manual Ultrasonic Eutectic Die Bonder with flip chip capability) or for both.
2. Decision of procurement of the Optional item (Manual Ultrasonic Eutectic Die Bonder with flip chip capability) fully depends on IIT Goa.
3. Vendors may represent two different manufacturers/principals for these two items: Multipurpose Convertible Wire Bonder, Manual Ultrasonic Eutectic Die Bonder with flip chip capability.
4. Vendors are allowed to participate only for optional item (Manual Ultrasonic Eutectic Die Bonder with flip chip capability).
5. Quote separately for individual items for Manual Ultrasonic Eutectic Die Bonder with flip chip capability.
6. Vendors are requested to submit all the related technical information. They may not be contacted for any technical details and any missing technical information may lead to rejection of the tender.
7. Vendors may be asked to perform wire bonding on the samples to be provided by IIT Goa. Unsuccessful performance will make their tenders rejected.

Multipurpose Convertible Wire Bonder

S.No.	Item	Technical Specs
1.	Wire Bonder type	- Multipurpose Convertible Ball - Wedge and Wedge-Wedge Wire Bonder
2.	Bonding Methods	- Bond methods by only tool change and a press of button conversion. - Vertical-feed or 90 and 45 degree wedge bonding. - EFO ball bonding.
3.	Machine Operation	- Should be microprocessor controlled with all programmed bond variable and machine settings for each tool head should

		<p>remain same in memory and should be retrieved automatically upon conversion.</p> <p>-Motorized Z axis, Manual X and Y axis with micro manipulator/lever.</p> <p>(Optional- Motorized Z & Y Axis and Manual X- axis with micro manipulator/lever can be quoted separately as an optional item)</p>
4.	Motorized Z- Axis Travel	System should have Motorized Z- travel more than 40 mm without any involvement of adjustable heater or work holder.
5.	Bond Tool depth access (Z axis)	System should have Bond Tool depth access (Z axis) min 40mm
6.	Machine Specifications	<ul style="list-style-type: none"> - Memory: RAM, with back-up options. - Display: LCD or LED
7.	U/S System	<ul style="list-style-type: none"> - 62.5 KHz Transducer. - Power: Within the range of 0 - 2 W (minimum). - Ultrasonic: Built-in.
8.	Wire And Tool Capability	Au/Al : 0.7 to 3.0 Mil , Ribbon: 1X10 mil or higher
9.	Bond Parameters	<ul style="list-style-type: none"> - Ball Formation: By EFO. - Parameters to be stored in the built-in memory. About bond schedules (Power, time and force) to be stored in non-volatile memory.
10.	Optics System	<ul style="list-style-type: none"> - Microscope: Stereo zoom ESD safe with 15X eyepieces and 4Xzoom or better. - Illuminator: Ring or LED Illuminator with stand-alone power supply and mounting hardware. - ESD protection for bonder and microscope.
11.	Work Stage	<ul style="list-style-type: none"> - Heated Work stage (ambient to 250 Deg C) for 2inch x 2inch or large size sample. - Work piece is to be held by mechanical clamping. - Suitable temperature controller.
12.	Bonding Wires	<p>a. Aluminum Wire: 2" spool of wire with 99% purity</p> <ul style="list-style-type: none"> - 1.0 mil wire: 100 meters length (1 Nos.) <p>b. Gold Wire: 2" spool of wire with 99.99% purity</p> <ul style="list-style-type: none"> - 1.0 mil wire: 100 meters length (1 Nos.)
13.	Bonding Tool	<ul style="list-style-type: none"> - Vertical feed wedge tool for - 1 mil (Au and Al) wire: 02 Nos each - Ball (capillary) bond tool for

		- 1 mil wire (Au): 03 Nos.
14.	Wire bonder starter tool kit	Allen keys , tweezers , Scissor --→ 1 number each
15.	Manuals	- Manuals in English language for operation and maintenance of the equipment.

Optional Item: Manual Ultrasonic Eutectic Die Bonder with flip chip capability

Sr. No	Item	Technical Specification
01	Manual Die Bonder	Manual Ultrasonic Eutectic Die Bonder with flip chip capability for micro assembly applications. Ideal for small components and ultra-fine pitch applications (Typically for. 4 x 4mil up to 100 x 100mil (100 x 100um to 2.5 x 2.5mm). Equipped with high-resolution video system and LED illumination.
02	Microscope with CCTV Camera Or UHD Video Camera	Color Video System including monitor, color camera, camera power adapter, microscope with built-in phototube, 30X eyepieces, mounting arm. LED Ring Illuminator with four quadrant controller and amplitude adjustment.
03	U/S System	- 62.5 KHz Transducer.
04		- Power: Within the range of 0 - 2 W (minimum). Digital adjustment of bond parameters in actual units (watts, milliseconds and grams).
05	Z axis movement	Servo-motorized vertical (Z axis) control.
06	Placement Accuracy:	Down to 10µm
07	Flip Chip Capability	die flipping mechanism for flip chip bonding
08	Work Stage	Heated Work stage (ambient to 450 Deg C) for 2inch x 2inch or large size sample. Work stage with rotating mirrored die holder and Nitrogen cover. Mechanical and vacuum clamping, surface dia.: 2.125 in. Adjustable work stage upto 3".

09	Die Collet - 2 Nos.	Deep access capability, 4 Sided Die Collet (Tungsten Carbide, 3/4", Tungsten Carbide.
10	Pick up tool- 2 Nos.	Pick Up Tool for die pick up
11	Power	240VAC 50/60 Hz Operation.
12	Manuals	- Manuals in English language for operation and maintenance of the equipment.

Terms and conditions

1	Power requirement: Compatible with Indian standard
2.	Warranty terms: 12 months warranty from date of Acceptance.
3.	Extended Warranty: Two years extended warranty must be quoted as option.
4.	Vendor should ensure that all goods/components are new and unused, and of the most recent or current models and that they incorporate all recent improvements in design and materials. Original certificates of all goods/components should be provided.
5.	Installation / commissioning should include complete demonstration at user site to verify functionalities and capabilities of the system quoted.
6.	The supplier should ensure availability of spares and consumables for at least ten years .
7.	Two persons should be trained in the laboratory for operation and basic maintenance.

(To be printed on letterhead of the bidder)

Annexure - C

Bidders Information

1.	Name of the Bidder	
2.	Address of the Bidder	
3.	PAN No.	
4.	GSTN No.	
5.	State of GST Registration	
6.	E-mail	
7.	Contact Person's Name & Designation	
8.	Mobile No.	

Indian Agent's Information

1.	Name of Indian Agent	
2.	Address of Indian Agent	
3.	Indian Agent PAN No.	
4.	Indian Agent GSTN No.	
5.	State of GST Registration	
6.	E-mail	
7.	Contact Person's Name & Designation	
8.	Mobile No.	

(To be printed on letterhead of the bidder)

Annexure - D

PRICE BID FORMAT

S.No.	Item description & short specification	HSN Code/SAC Code	Qty in Units	GST %	Price Basis	Total Bid Price
1.	Multipurpose Convertible Wire Bonder					
2.	Installation and Commissioning Charges (if any, quote in INR)					
3.	Agency Commission (if any, quote in %)					
4.	Other Charges (if any, please specify)					
Grand Total						

#HSN Code: "Harmonized System of Nomenclature Code No." and SAC Code: "Service Accounting Codes Code No."

1. Delivery Period: 45 days.

2. Validity of the bid: 120 days from the date of submission of quotation/tender.

Signature.....

Name

Place:

Company Name & Address:

Date:

Affix Rubber Stamp:

Note: Price Bid should be submitted in given format only. For additional information/extra items above format may be typed and used.

Reasonability of Prices

Please quote best minimum prices applicable for a premier Educational and Research Institution. The party must give details of at least two purchase orders identical or similar equipment, supplied to any IITS/Research Institutions/ other organisation as per below Format (to be enclosed in Financial Bid) along with the final price paid and details are mandatory.

Previous Supply Orders

Name of the Firm _____

S.No.	PO No. & Date	Description & Quantity of ordered equipment	Value of Order	Date of completion of delivery as per contract	Remarks indicating reasons for late delivery, if any and justification of price difference of their supply order & those quoted to us	Has the equipment being installed satisfactorily (attach a certificate from the Purchaser/ Consigner)	Contact Person along with Telephone no., Fax No. and e-mail address

Place: _____

Date: _____

Signature and Seal of the Manufacturer / Bidder

FORMAT FOR PERFORMANCE GUARANTEE BOND

(To be typed on **Non-judicial stamp paper** of the value of Indian Rupees of One Hundred) (TO BE ESTABLISHED THROUGH ANY OF THE NATIONAL BANKS (WHETHER SITUATED AT GOA OR OUTSTATION) WITH A CLAUSE TO ENFORCE THE SAME ON THEIR LOCAL BRANCH AT GOA OR ANY SCHEDULED BANK SITUATED AT GOA. BONDS ISSUED BY CO-OPERATIVE BANKS ARE NOT ACCEPTED.

To,
The Registrar,
Indian Institute of Technology, Goa
Farmagudi, Ponda,
Goa – 403401

LETTER OF GUARANTEE

WHEREAS Indian Institute of Technology, Goa (Buyer) have invited Tenders vide Tender No..... Dt. for purchase of

AND

WHEREAS the said tender document requires that any eligible successful tenderer (seller) wishing to supply the equipment / machinery, etc. in response thereto shall establish an irrevocable Performance Guarantee Bond in favour of “**Registrar, Indian Institute of Technology, Goa**” in the form of Bank Guarantee for Rs (**3% (Three percent) of the purchase value**) and valid till **one year or up to warranty period plus sixty days whichever is later** from the date of issue of Purchase Order. Performance Guarantee Bond may be submitted within 15 (Fifteen) days from the date of Order Acknowledgment as a successful bidder.

NOW THIS BANK HEREBY GUARANTEES that in the event of the said tenderer (seller) failing to abide by any of the conditions referred in tender document / purchase order / performance of the equipment / machinery, etc. this Bank shall pay to Indian Institute of Technology, Goa on demand and without protest or demur Rs..... (Rupees.....).

This Bank further agrees that the decision of Indian Institute of Technology, Goa (Buyer) as to whether the said Tenderer (Seller) has committed a breach of any of the conditions referred in tender document / purchase order shall be final and binding.

We, (name of the Bank & branch) hereby further agree that the Guarantee herein contained shall not be affected by any change in the constitution of the Tenderer (Seller) and/ or Indian Institute of Technology, Goa (Buyer).

Notwithstanding anything contained herein:

1. Our liability under this Bank Guarantee shall not exceed Rs.
(Indian Rupees only).
2. This Bank Guarantee shall be valid up to(date) and
3. We are liable to pay the guaranteed amount or any part thereof under this bank guarantee only and only if IIT Goa serve upon us a written claim or demand on or before(date).
4. This Bank further agrees that the claims if any, against this Bank Guarantee shall be enforceable at our branch office at situated at
(Address of local branch).

Date:

Yours truly,
Signature and seal of the Guarantor:

Name of Bank:

Instruction to Bank: Bank should note that on expiry of Bond Period, the Original Bond will not be returned to the Bank. Bank is requested to take appropriate necessary action on or after expiry of bond period.

UNDERTAKING FOR BID SECURITY

(To be issued by the bidder on company's letterhead in lieu of EMD)

To,
The Registrar,
Indian Institute of Technology Goa,
At GEC Campus, Farmagudi, Ponda – Goa

We, M/s (name of the firm), with ref. to enquiry no. dtd hereby undertake that:

- 1) We accept all the terms and conditions of the tender document.
- 2) We accept that, we will not modify our bid during the bid validity period, submit performance guarantee within the stipulated period and honor the contract after award of contract.
- 3) In the event of any modification to our bid by us or failure on our part to honor the contract after final award or failure to submit performance guarantee, our firm may be debarred from participation in any tender/contract notified by Indian Institute of Technology, Goa for a period of one year.

Yours faithfully,
(Signature of the bidder with date and seal)

DECLARATION OF LOCAL CONTENT

(To be given on company letter head - For tender value below Rs.10 crores)
(To be given by Statutory Auditor/Cost Auditor/Cost Accountant/CA for tender value above
Rs.10 crores)

Date:

To,
The Registrar,
Indian Institute of Technology Goa,
At GEC Campus, Farmagudi, Ponda - Goa

Sub: Declaration of Local content

Tender Reference No: _____

Name of Tender: - _____

Country of Origin of Goods being offered: _____

We hereby declare that an item offered has _____ % local content. _____

“Local Content” means the amount of value added in India which shall, be the total value of the item being offered minus the value of the imported content in the item (including all customs duties) as a proportion of the total value, in percent.

We understand that, as per Office Memorandum dated 04/03/2021 issued by Ministry of Commerce and Industry, services such as transportation, insurance, installation, commissioning, training and after sales support like AMC/CMC etc. are not considered as local value addition.

“*False declaration will be in breach of Code of Integrity under Rule 175(1)(i)(h) of the General Financial Rules for which a bidder or its successors can be debarred for up to two years as per Rule 151 (iii) of the General Financial Rules along with such other actions as may be permissible under law.”

Yours faithfully,

(Signature of the Bidder, with Official Seal)